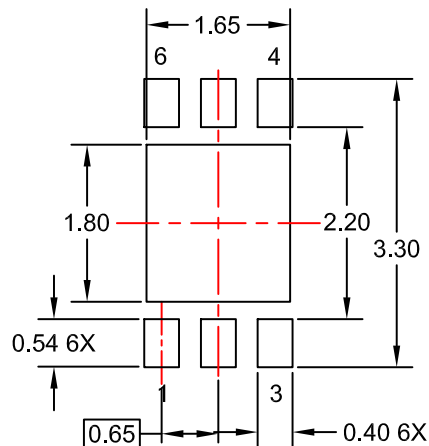
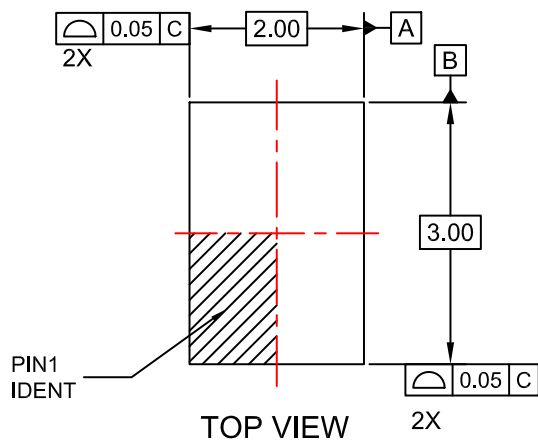
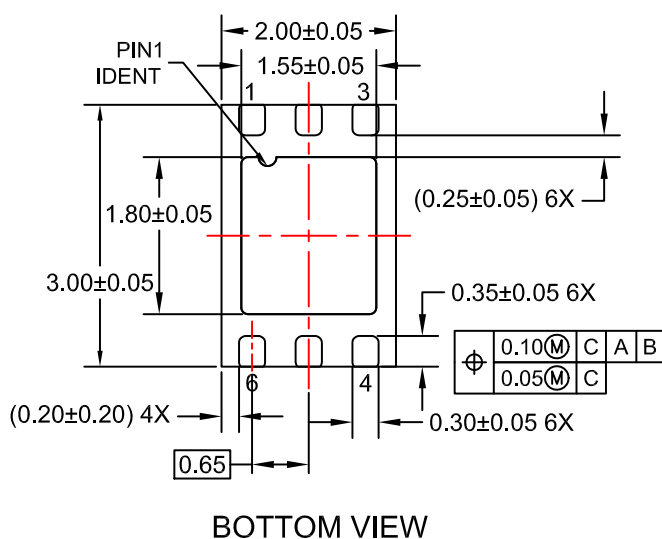
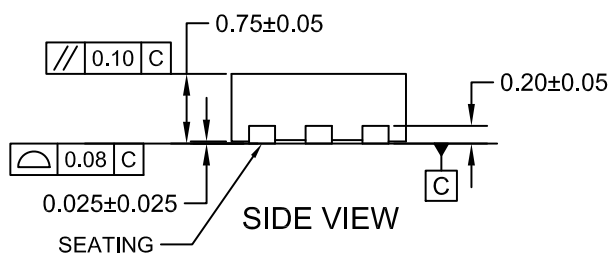


WDFN6 2x3, 0.65P
CASE 511CX
ISSUE O

DATE 31 JUL 2016



RECOMMENDED LAND PATTERN



NOTES:

- A. PACKAGE CONFORMS TO JEDEC MO-229 EXCEPT WHERE NOTED.
- B. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- C. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- D. DIMENSIONS ARE IN MILLIMETERS.
- E. REFERENCE DIMENSIONS ARE UNCONTROLLED

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DESCRIPTION:	WDFN6 2X3, 0.65P	PAGE 1 OF 1

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